

# LOW-NOISE JFET-INPUT OPERATIONAL AMPLIFIER

Check for Samples: TL072-EP, TL074-EP

#### **FEATURES**

- Low Power Consumption
- Wide Common-Mode and Differential Voltage Ranges
- Low Input Bias and Offset Currents
- Output Short-Circuit Protection
- Low Total Harmonic Distortion: 0.003% Typ
- Low Noise

 $V_n = 18 \text{ nV}/\sqrt{\text{Hz}}$  Typ at f = 1 kHz

- High Input Impedance: JFET Input Stage
- Internal Frequency Compensation
- Latch-Up-Free Operation
- High Slew Rate: 13 V/µs Typ
- Common-Mode Input Voltage Range Includes V<sub>CC+</sub>

# SUPPORTS DEFENSE, AEROSPACE, AND MEDICAL APPLICATIONS

- Controlled Baseline
- One Assembly and Test Site
- One Fabrication Site
- Available in Extended (–40°C to 125°C) or Military (–55°C to 125°C) Temperature Range
- Extended Product Life Cycle
- Extended Product-Change Notification
- Product Traceability

#### DESCRIPTION/ORDERING INFORMATION

The JFET-input operational amplifiers in the TL07x is similar to the TL08x series, with low input bias and offset currents and fast slew rate. The low harmonic distortion and low noise make the TL07x ideally suited for high-fidelity and audio preamplifier applications. Each amplifier features JFET inputs (for high input impedance) coupled with bipolar output stages integrated on a single monolithic chip.

The TL07x is characterized for operation over the extended temperature range of  $-40^{\circ}$ C to  $125^{\circ}$ C or military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C.

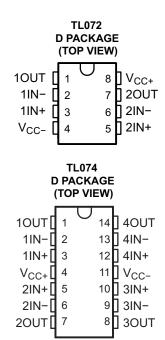
#### ORDERING INFORMATION<sup>(1)</sup>

T <sub>A</sub>	V <sub>IO</sub> maX AT 25°C	PACKAGE				ORDERABLE PART NUMBER	TOP-SIDE MARKING	VID NUMBER
-40°C to 125°C	6 mV	SOIC - D	Reel of 2500	TL072QDREP	TL072Q	V62/12604-01XE		
-40°C to 125°C	6 111 0	30IC - D	Reel 01 2500	TL074QDREP	TL074Q	V62/11621-01XE		
FE°C to 125°C	6 mV	SOIC - D	Reel of 2500	TL074MDREP	TL074M	V62/11621-02XE		
–55°C to 125°C	6 111 0	201C – D	Tube of 75	TL074MDEP	TL074M	V62/11621-02XE-T		

For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI
website at www.ti.com.

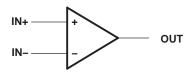


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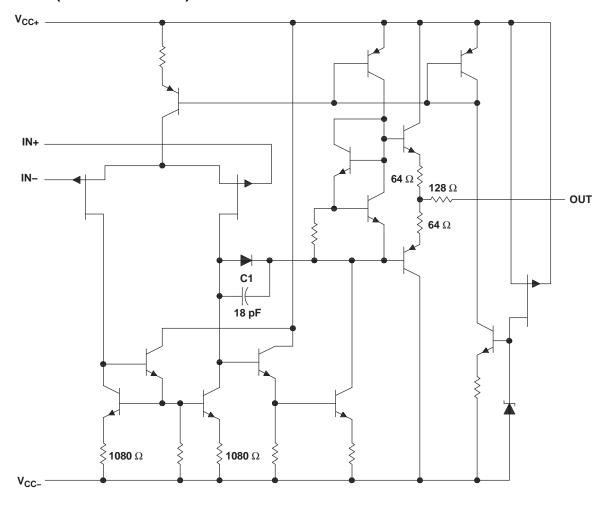




#### TL072 and TL074 SYMBOL (EACH AMPLIFIER)



# **SCHEMATIC (EACH AMPLIFIER)**



All component values shown are nominal.

	COMPONENT COUNT <sup>(1)</sup>									
COMPONENT TYPE	TL072	TL074								
Resistors	22	44								
Transistors	28	56								
JFET	4	6								
Diodes	2	4								
Capacitors	2	4								
epi-FET	2	4								

(1) Includes bias and trim circuitry

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#### **ABSOLUTE MAXIMUM RATINGS(1)**

over operating free-air temperature range (unless otherwise noted)

				MIN	MAX	UNIT	
V <sub>CC+</sub>	Supply voltage <sup>(2)</sup>				\/		
V <sub>CC</sub> -	Supply voltage >>					V	
$V_{ID}$	Differential input voltage <sup>(3)</sup>				±30	V	
VI	Input voltage <sup>(2) (4)</sup>				±15	V	
	Duration of output short circuit <sup>(5)</sup>			Unlimi	ted		
0	The arrest resistance is matical to each in at (6) (7)	TL072			97.5	°C/W	
$\theta_{JA}$	Thermal resistance, junction-to-ambient <sup>(6)</sup> (7)	TL074			86		
0	The arrest resistance is matical to accept (7)	TL072			38.3	00.004	
$\theta_{JC}$	Thermal resistance, junction-to-case <sup>(7)</sup>	TL074			51.5	°C/W	
TJ	Operating virtual junction temperature				150	°C	
T <sub>stg</sub>	Storage temperature range			-65	150	°C	

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Product Folder Links: TL072-EP TL074-EP

<sup>(2)</sup> All voltage values, except differential voltages, are with respect to the midpoint between V<sub>CC+</sub> and V<sub>CC-</sub>

<sup>3)</sup> Differential voltages are at IN+, with respect to IN-.

<sup>(4)</sup> The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 V, whichever is less.

<sup>(5)</sup> The output may be shorted to ground or to either supply. Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.

<sup>(6)</sup> Operating at the absolute maximum T<sub>J</sub> of 150°C can affect reliability.

<sup>(7)</sup> The package thermal impedance is calculated in accordance with JESD 51-7.



#### **ELECTRICAL CHARACTERISTICS**

 $V_{CC\pm} = \pm 15 \text{ V}$  (unless otherwise noted)

	DADAMETED	TECT CONDITIONS(1)	<b>T</b> (2)		TL072			TL074		UNIT
	PARAMETER	TEST CONDITIONS <sup>(1)</sup>	T <sub>A</sub> <sup>(2)</sup>	MIN	TYP	MAX	MIN	TYP	MAX	UNII
V	longt offeet velters	$V_{\Omega} = 0, R_{S} = 50 \Omega$	25°C		3	6		3	6	mV
$V_{IO}$	Input offset voltage	$V_0 = 0, R_S = 50 \Omega$	Full range			8			8	mv
$\alpha_{\text{VIO}}$	Temperature coefficient of input offset voltage	$V_{O} = 0, R_{S} = 50 \Omega$	Full range		18			18		μV/°C
	Input offset current	V <sub>O</sub> = 0	25°C		5	100		5	100	pА
I <sub>IO</sub>	input onset current	v <sub>O</sub> = 0	125°C			2			2	nA
	Input bias current	V <sub>O</sub> = 0	25°C		65	200		65	200	pA
I <sub>IB</sub>	input bias current	v <sub>O</sub> = 0	125°C			20			20	nA
$V_{ICR}$	Common-mode input voltage range		25°C	±11	-12 to 15		±11	-12 to 15		V
		$R_L = 10 \text{ k}\Omega$	25°C	±12	±13.5		±12	±13.5		
$V_{OM}$	Maximum peak output voltage swing	R <sub>L</sub> ≥ 10 kΩ	Full rooms	±12			±12			V
	romago omnig	R <sub>L</sub> ≥ 2 kΩ	Full range	±10			±10			
۸	Large-signal differential	$V_{\Omega} = \pm 10 \text{ V}, R_{\parallel} \ge 2 \text{ k}\Omega$	25°C	35	200		35	200		V/mV
$A_{VD}$	voltage amplification	$V_0 = \pm 10 \text{ V}, R_L \ge 2 \text{ K}\Omega$	Full range	15			15			V/IIIV
B <sub>1</sub>	Unity-gain bandwidth		25°C		3			3		MHz
r <sub>i</sub>	Input resistance		25°C		10 <sup>12</sup>			10 <sup>12</sup>		Ω
CMRR	Common-mode rejection ratio	$V_{IC} = V_{ICR} min,$ $V_O = 0, R_S = 50 \Omega$	25°C	80	86		80	86		dB
k <sub>SVR</sub>	Supply-voltage rejection ratio ( $\Delta V_{CC} \pm /\Delta V_{IO}$ )	$V_{CC} = \pm 9 \text{ V to } \pm 15 \text{ V},$ $V_{O} = 0, R_{S} = 50 \Omega$	25°C	80	86		80	86		dB
I <sub>CC</sub>	Supply current (each amplifier)	V <sub>O</sub> = 0, No load	25°C		1.4	2.5		1.4	2.5	mA
V <sub>O1</sub> /V <sub>O2</sub>	Crosstalk attenuation	A <sub>VD</sub> = 100	25°C		120	-		120		dB

<sup>(1)</sup> Input bias currents of an FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive, as shown in Figure 3. Pulse techniques must be used that will maintain the junction temperature as close to the ambient temperature as possible.

#### **OPERATING CHARACTERISTICS**

 $V_{CC\pm} = \pm 15 \text{ V}, T_A = 25^{\circ}\text{C}$ 

	PARAMETER	TEST	CONDITIONS	7	TL072		1	ΓL074		UNIT
	PARAMETER	IESI	CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNII
SR	Slew rate at unity gain	$V_I = 10 \text{ V},$ $C_L = 100 \text{ pF},$	$R_L = 2 k\Omega$ , See Figure 1	8	13		8	13		V/µs
	Rise-time overshoot	$V_1 = 20 V$ ,	$V$ , $R_L = 2 k\Omega$ ,		0.1			0.1		μs
L <sub>r</sub>	factor	$C_L = 100 \text{ pF},$	See Figure 1		20			20		%
V	. Equivalent input noise	$R_S = 20 \Omega$	f = 1 kHz		18			18		nV/√ <del>Hz</del>
V <sub>n</sub>	voltage	$R_S = 20 \Omega$	f = 10 Hz to 10 kHz		4			4		μV
In	Equivalent input noise current	$R_S = 20 \Omega$ ,	f = 1 kHz		0.01			0.01		pA/√Hz
THD	Total harmonic distortion	$V_{l}rms = 6 V,$ $R_{L} \ge 2 k\Omega,$ $f = 1 kHz,$	$A_{VD} = 1$ , RS $\leq 1 \text{ k}\Omega$ ,		0.003			0.003		%

Product Folder Links: TL072-EP TL074-EP

<sup>(2)</sup> All characteristics are measured under open-loop conditions with zero common-mode voltage, unless otherwise specified. Full range is T<sub>A</sub> = -40°C to 125°C for TL07xQ and T<sub>A</sub> = -55°C to 125°C for TL07xM.



#### PARAMETER MEASUREMENT INFORMATION

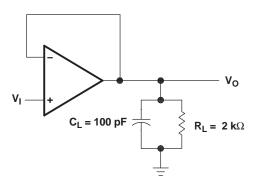


Figure 1. Unity-Gain Amplifier

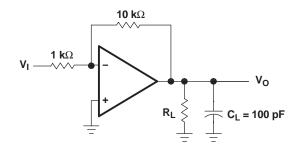


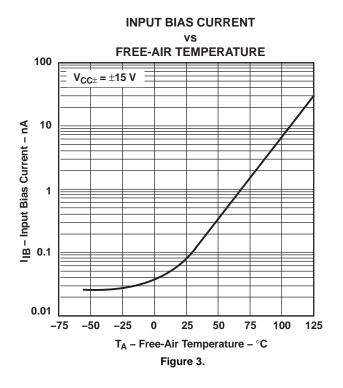
Figure 2. Gain-of-10 Inverting Amplifier

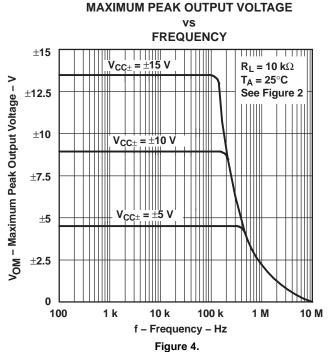
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#### TYPICAL CHARACTERISTICS

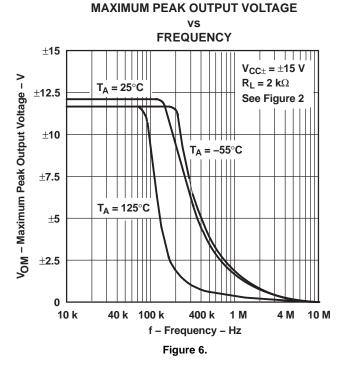
Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.





#### **MAXIMUM PEAK OUTPUT VOLTAGE** vs **FREQUENCY** ±15 $R_L = 2 k\Omega$ V<sub>OM</sub> - Maximum Peak Output Voltage - V T<sub>A</sub> = 25°C ±12.5 See Figure 2 ±10 $V_{CC\pm} = \pm 10 \text{ V}$ ±7.5 ±5 $V_{CC\pm} = \pm 5 \text{ V}$ ±2.5 0 100 1 k 10 k 100 k 1 M 10 M f - Frequency - Hz

Figure 5.



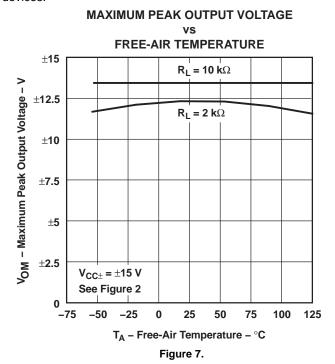
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#### **TYPICAL CHARACTERISTICS (continued)**

Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



## **MAXIMUM PEAK OUTPUT VOLTAGE** vs LOAD RESISTANCE ±15 $V_{CC\pm} = \pm 15 \text{ V}$ VOM - Maximum Peak Output Voltage - V T<sub>A</sub> = 25°C ±12.5 See Figure 2 ±10 ±7.5 ±5 ±2.5 0.1 0.2 0.7 1 7 10 $R_L$ – Load Resistance – $k\Omega$ Figure 8.

# MAXIMUM PEAK OUTPUT VOLTAGE

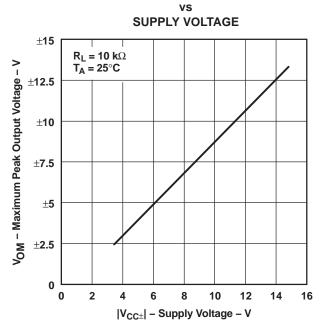
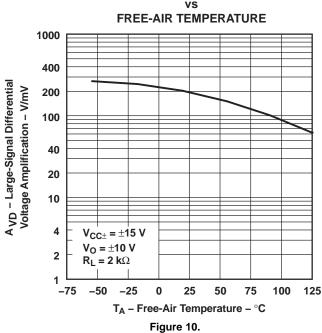


Figure 9.

# LARGE-SIGNAL DIFFERENTIAL VOLTAGE AMPLIFICATION



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0.97

100 125



#### **TYPICAL CHARACTERISTICS (continued)**

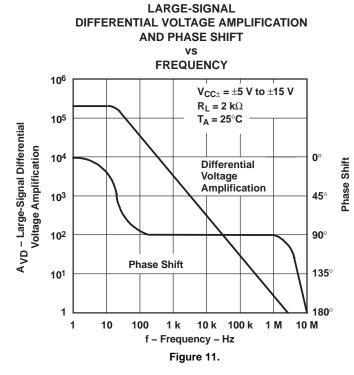
0.7 └─ -75

-50

-25

0

Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



#### **AND PHASE SHIFT** vs FREE-AIR TEMPERATURE 1.03 1.3 **Unity-Gain Bandwidth** 1.02 1.2 Normalized Unity-Gain Bandwidth Normalized Phase Shift 1.01 1.1 **Phase Shift** 0.99 0.9 $V_{CC\pm} = \pm 15 \text{ V}$ 0.98 0.8 $R_L = 2 k\Omega$ f = B<sub>1</sub> for Phase Shift

**NORMALIZED UNITY-GAIN BANDWIDTH** 

# COMMON-MODE REJECTION RATIO

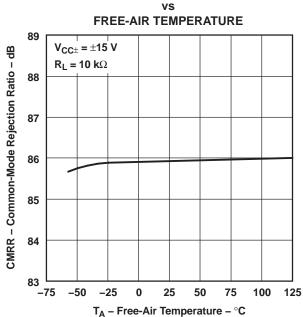


Figure 13.

## SUPPLY CURRENT PER AMPLIFIER

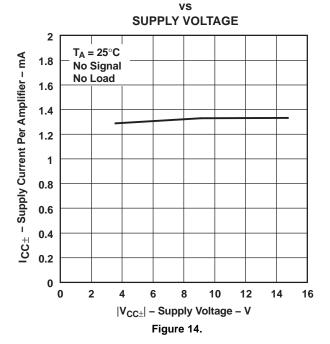
Figure 12.

50

75

25

T<sub>A</sub> - Free-Air Temperature - °C



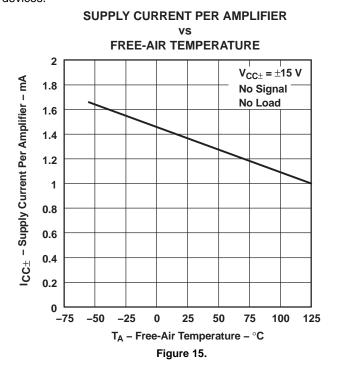
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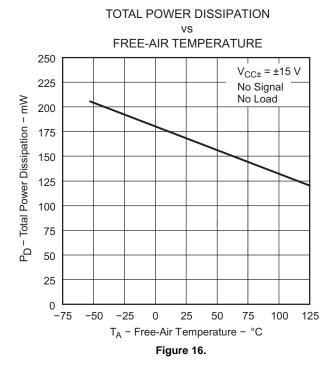
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#### **TYPICAL CHARACTERISTICS (continued)**

Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.





# FREE-AIR TEMPERATURE 1.15 $V_{CC\pm} = \pm 15 \text{ V}$ $R_L = 2 \text{ k}\Omega$ $C_L = 100 \text{ pF}$ 1.05 0.95 0.90

0

25

T<sub>A</sub> – Free-Air Temperature – °C Figure 17.

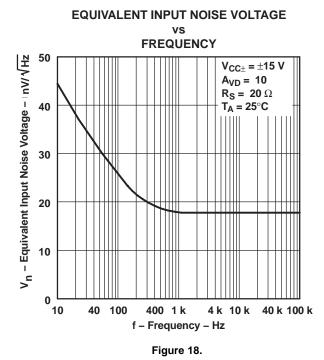
50

75

100

125

**NORMALIZED SLEW RATE** 



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0.85

\_75

-50

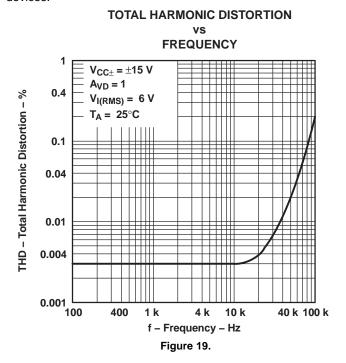
-25

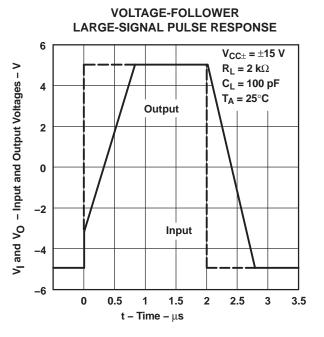
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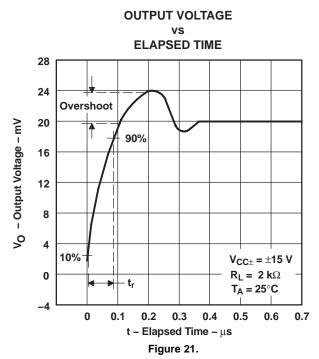
#### TYPICAL CHARACTERISTICS (continued)

Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.





#### Figure 20.

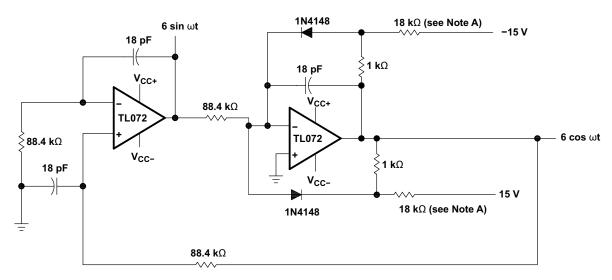


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#### **APPLICATION INFORMATION**



NOTE A: These resistor values may be adjusted for a symmetrical output.

Figure 22. 100-kHz Quadrature Oscillator

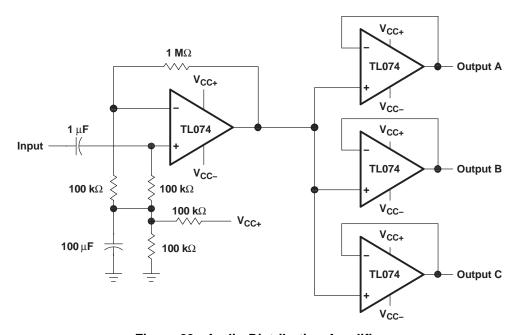


Figure 23. Audio-Distribution Amplifier

Product Folder Links: TL072-EP TL074-EP

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#### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
TL072QDREP	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	TL072Q
TL072QDREP.A	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	TL072Q
TL074MDEP	Active	Production	SOIC (D)   14	50   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	TL074M
TL074MDEP.A	Active	Production	SOIC (D)   14	50   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	TL074M
TL074MDREP	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	TL074M
TL074MDREP.A	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	TL074M
TL074QDREP	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	TL074Q
TL074QDREP.A	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	TL074Q
V62/11621-01XE	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	TL074Q
V62/11621-02XE	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	TL074M
V62/11621-02XE-T	Active	Production	SOIC (D)   14	50   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-55 to 125	TL074M
V62/12604-01XE	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	TL072Q

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

### PACKAGE OPTION ADDENDUM

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#### OTHER QUALIFIED VERSIONS OF TL072-EP, TL074-EP:

Catalog: TL072, TL074

Military: TL072M, TL074M

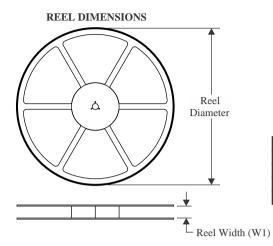
NOTE: Qualified Version Definitions:

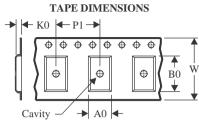
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

**PACKAGE MATERIALS INFORMATION** 

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#### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL072QDREP	SOIC	D	8	2500	330.0	12.5	6.4	5.2	2.1	8.0	12.0	Q1
TL074MDREP	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
TL074QDREP	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1



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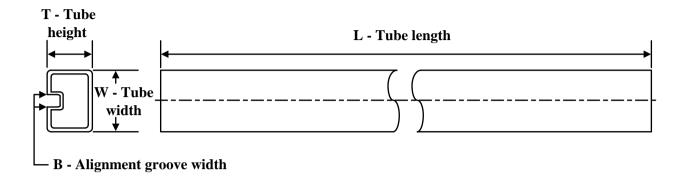
#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL072QDREP	SOIC	D	8	2500	340.5	338.1	20.6
TL074MDREP	SOIC	D	14	2500	340.5	336.1	32.0
TL074QDREP	SOIC	D	14	2500	353.0	353.0	32.0

# **PACKAGE MATERIALS INFORMATION**

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#### **TUBE**



#### \*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
TL074MDEP	D	SOIC	14	50	507	8	3940	4.32
TL074MDEP.A	D	SOIC	14	50	507	8	3940	4.32
V62/11621-02XE-T	D	SOIC	14	50	507	8	3940	4.32





#### NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
- 5. Reference JEDEC registration MS-012, variation AB.





NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.







#### NOTES:

- 1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.





NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.





NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
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